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(12) **United States Design Patent**
Wang

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(54) **EARPHONE**

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(72) Inventor: **Baoqing Wang**, Shenzhen (CN)

(**) Term: **15 Years**

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(51) **LOC (13) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223**

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USPC D14/223, 188, 192; D24/174;
128/864-866; 381/380, 381, 328, 322;
455/90.3, 575.1, 569.1
CPC H04R 1/10; H04R 1/1066; H04R 1/1016;
H04R 5/033; H04R 5/0335; H04R 25/00;
H04R 1/1091

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for an earphone, as shown and described.

DESCRIPTION

FIG. 1 is a first perspective view of an earphone showing my new design;

FIG. 2 is a second perspective view thereof;

FIG. 3 is a front view thereof;

FIG. 4 is a back view thereof;

FIG. 5 is a left side view thereof;

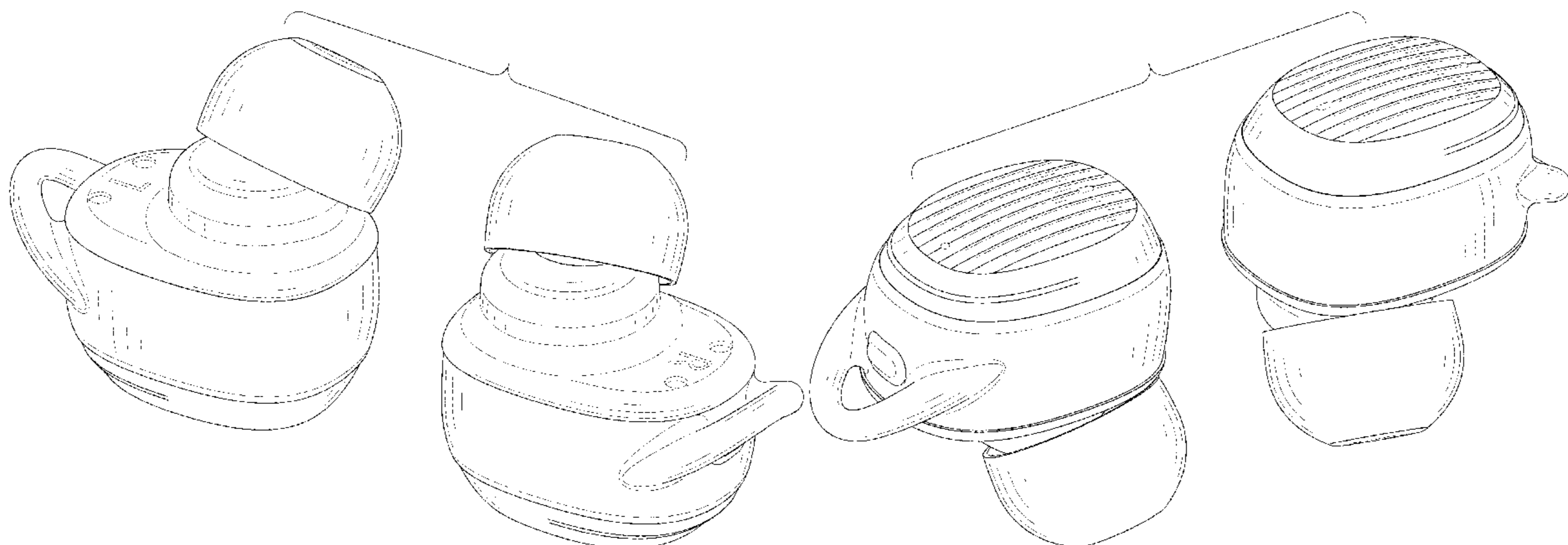
FIG. 6 is a right side view thereof;

FIG. 7 is a top view thereof; and,

FIG. 8 is a bottom view thereof.

The broken lines shown in the drawings depict portions of the earphone in which the design is embodied that form no part of the claimed design.

1 Claim, 8 Drawing Sheets



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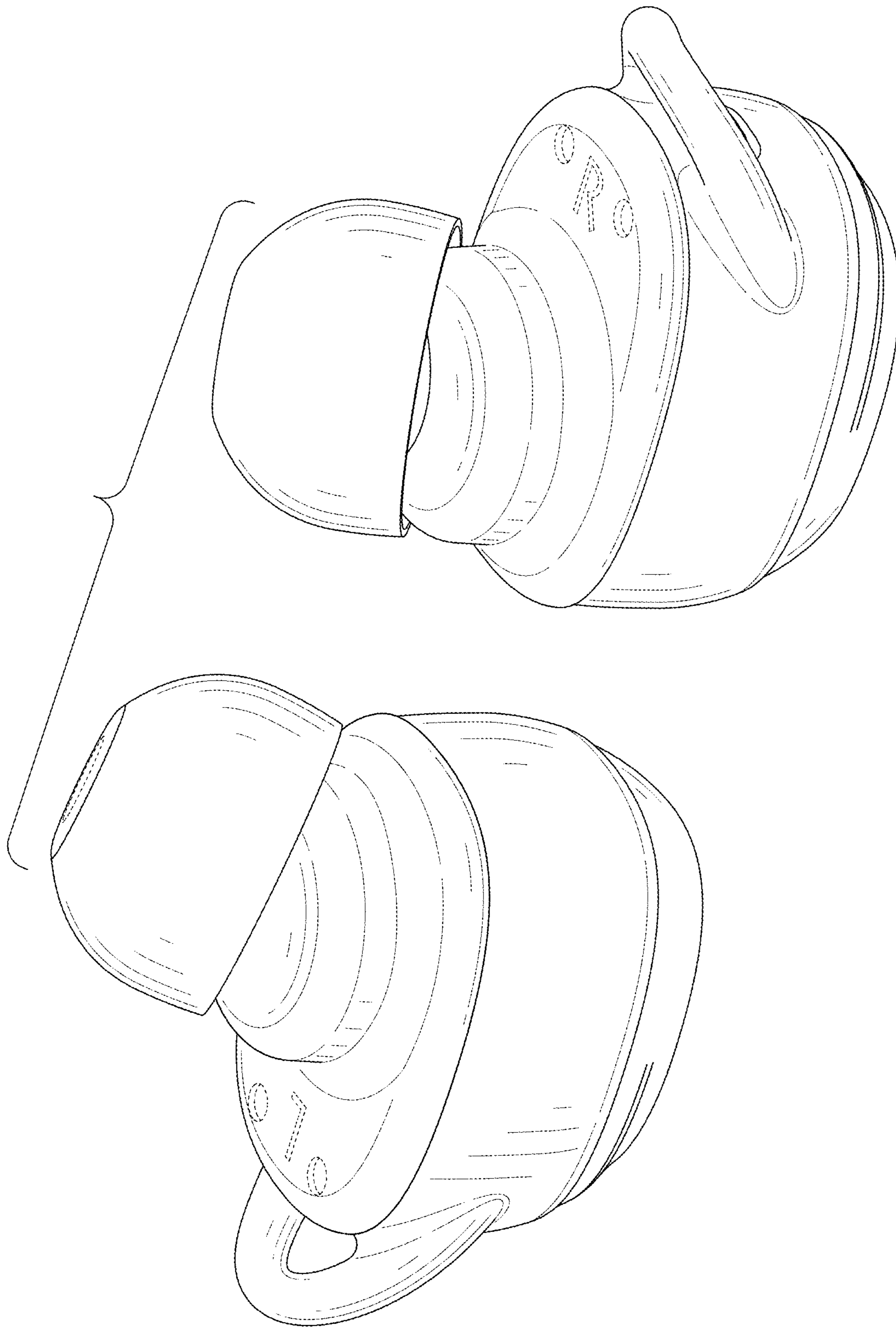


FIG. 1

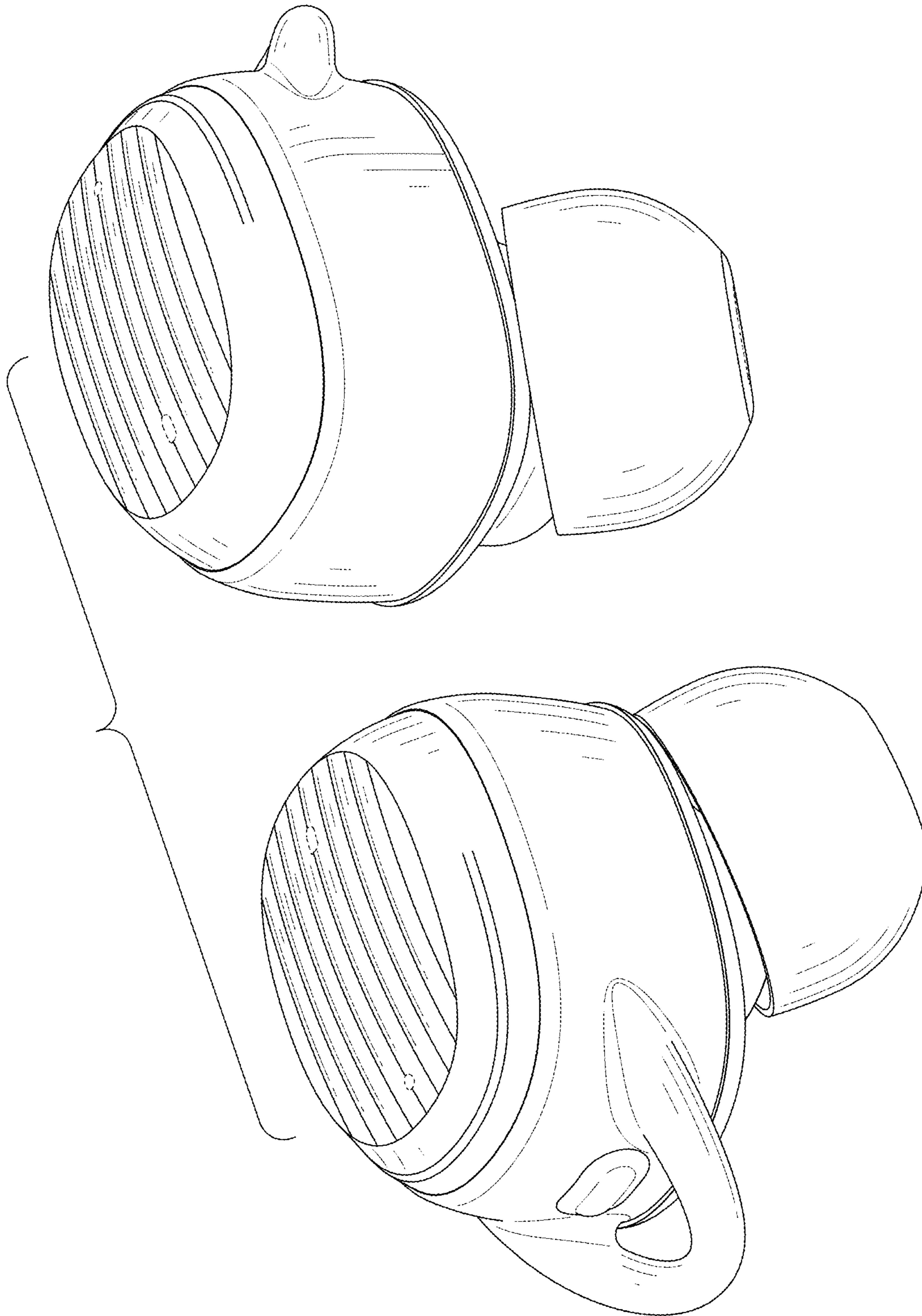


FIG. 2

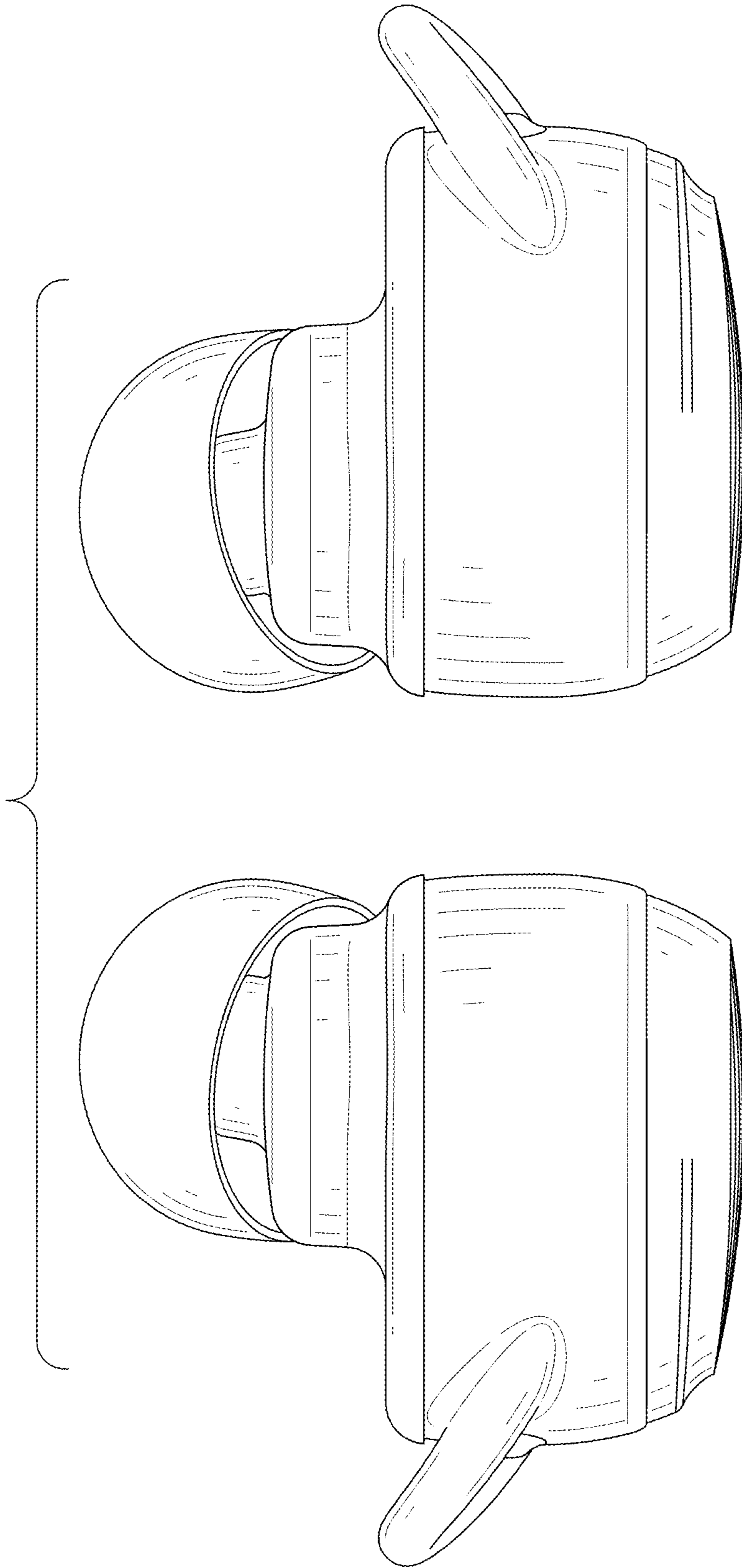


FIG. 3

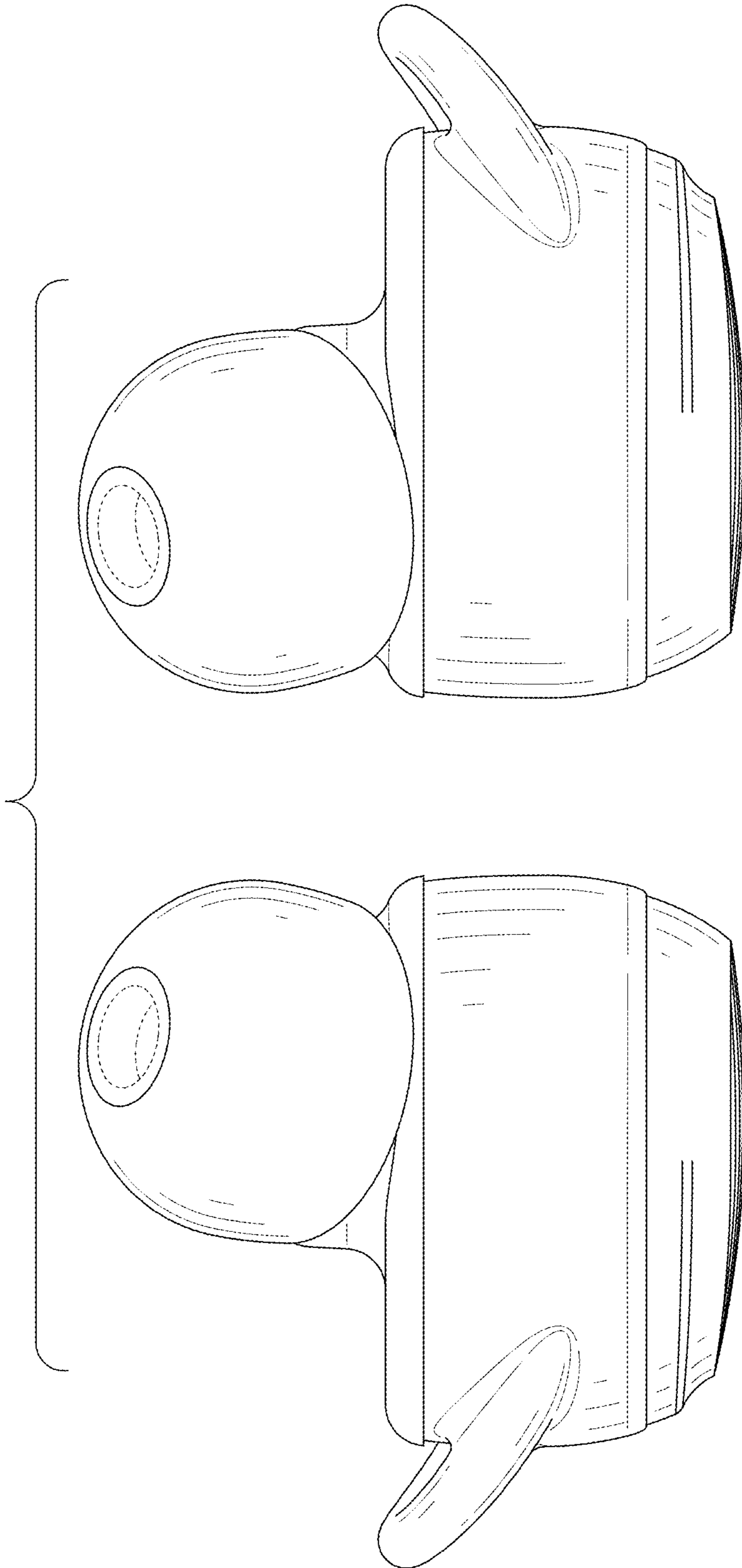


FIG. 4

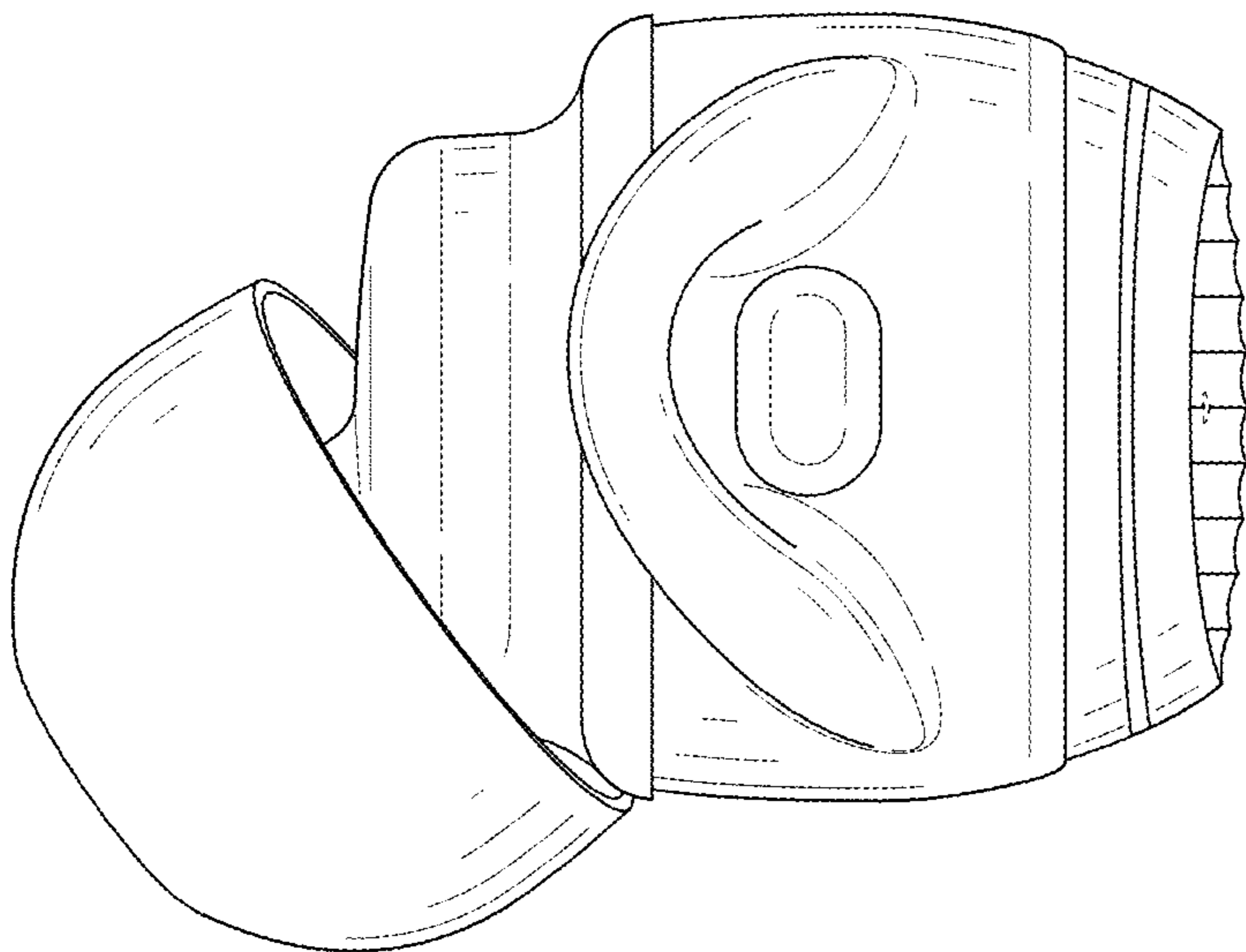


FIG. 5

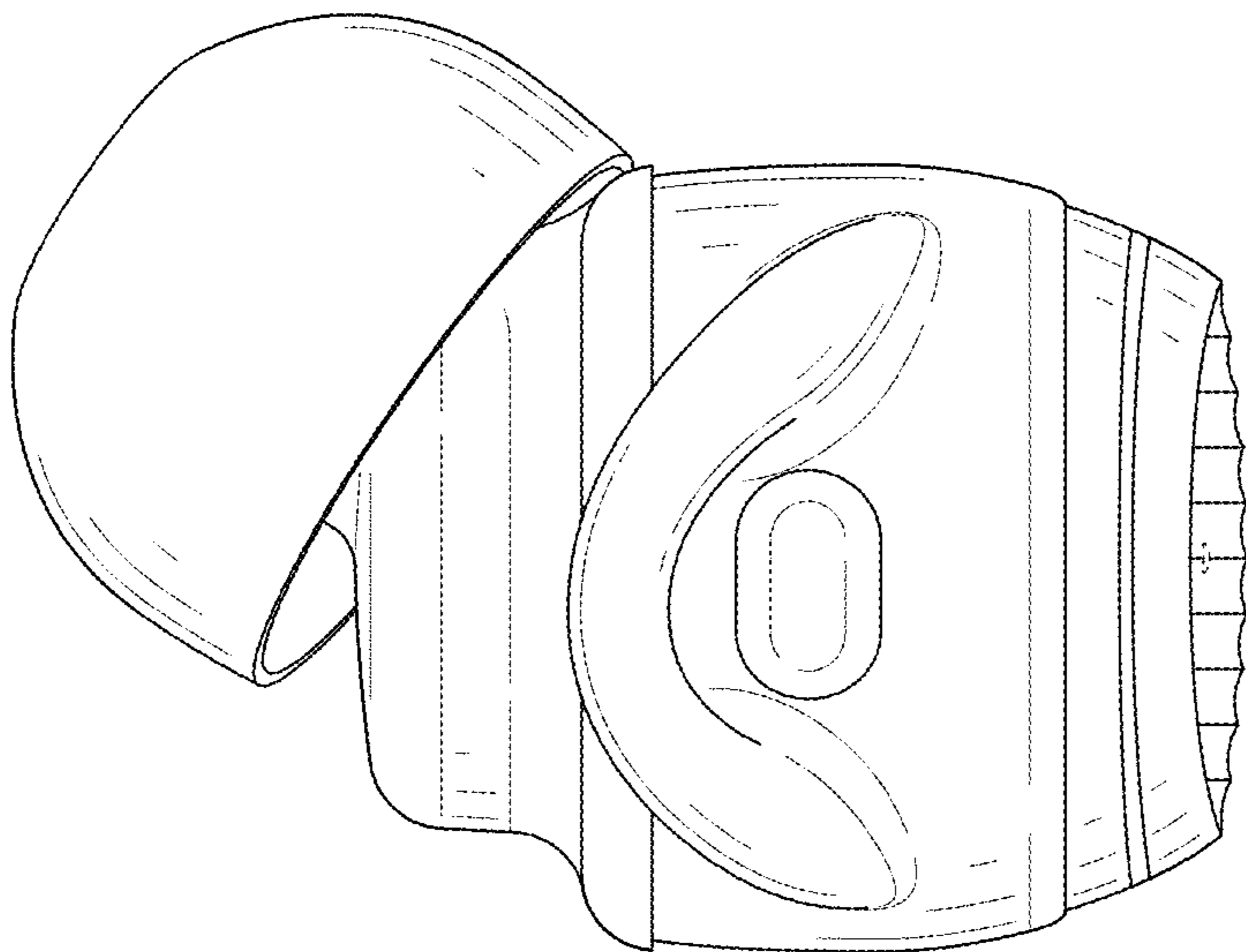


FIG. 6

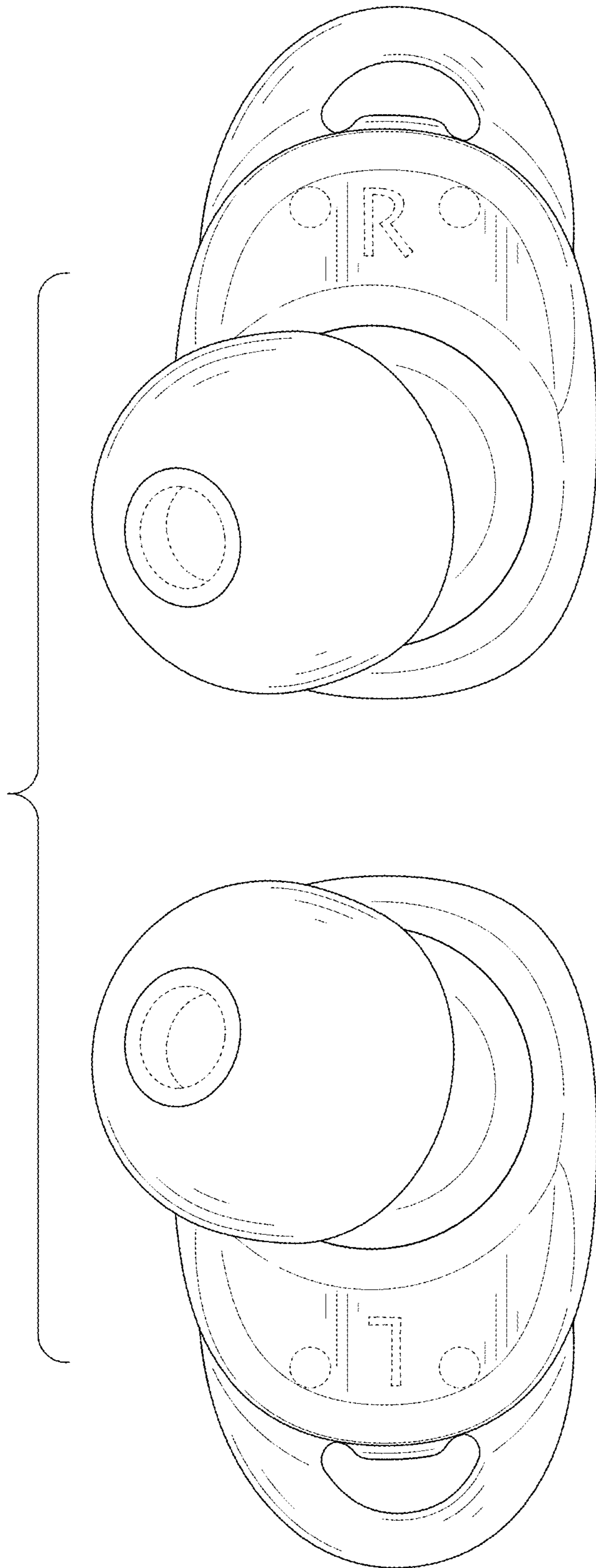


FIG. 7

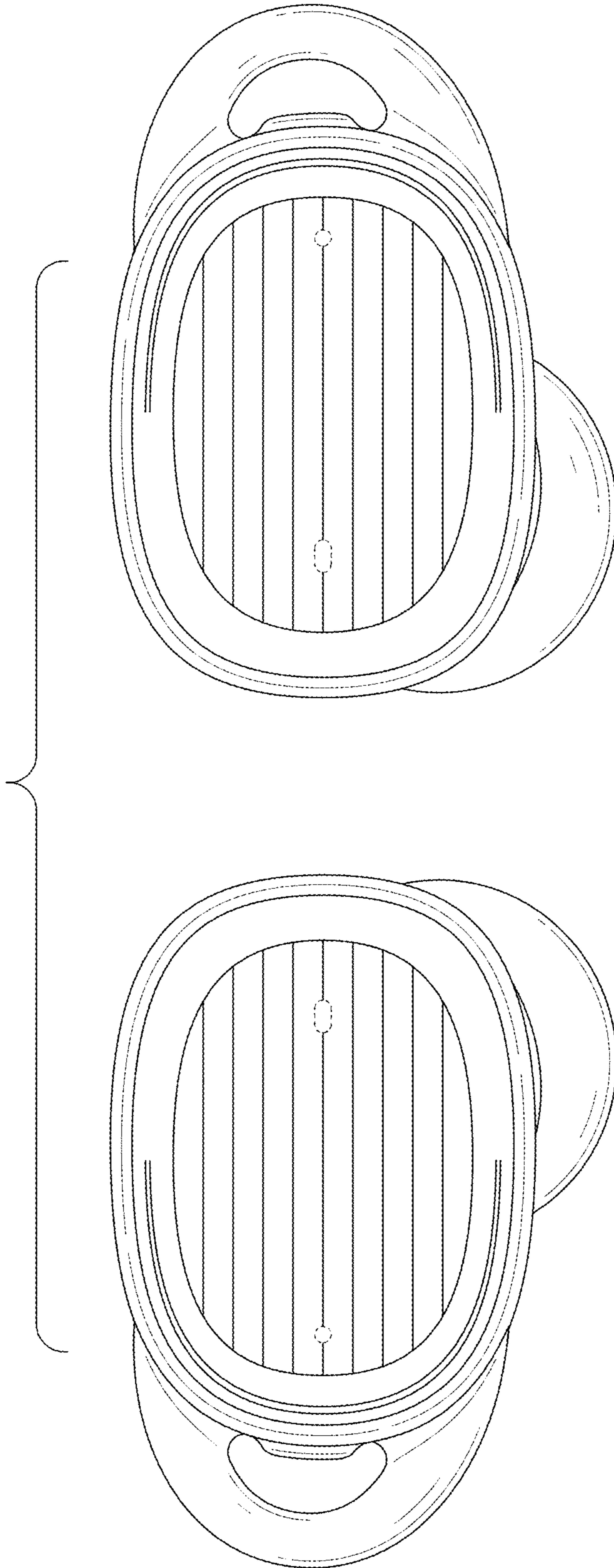


FIG. 8